

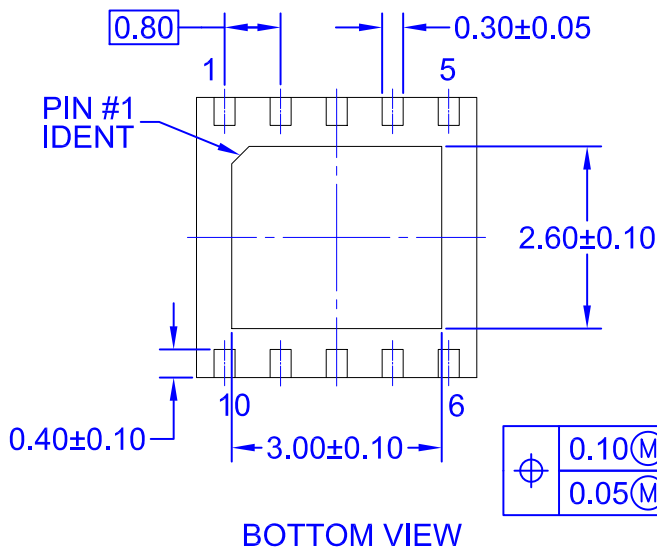
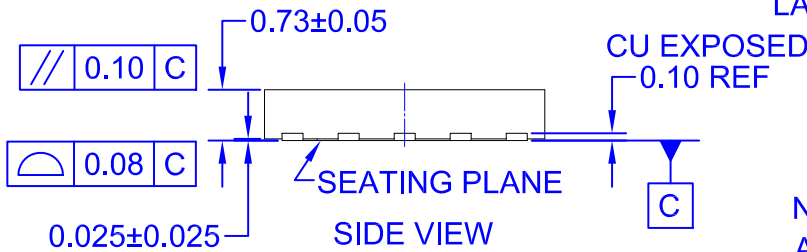
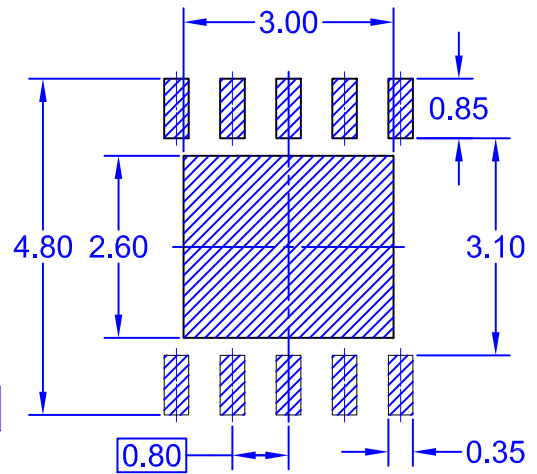
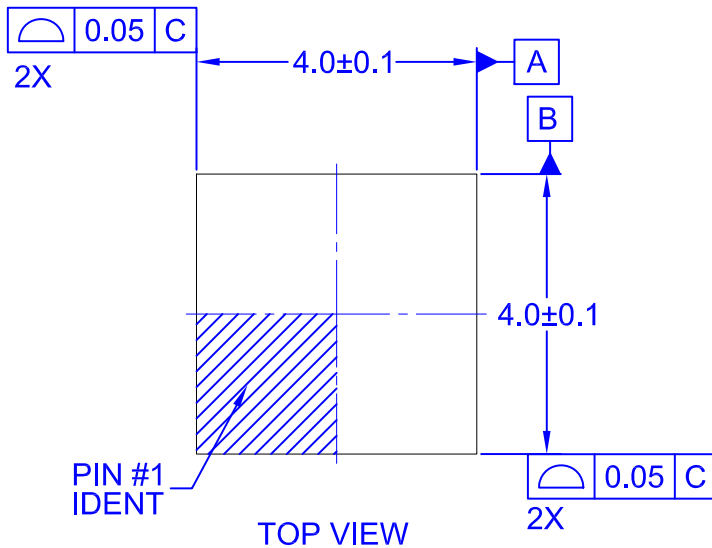
**MECHANICAL CASE OUTLINE**  
**PACKAGE DIMENSIONS**

ON Semiconductor®



WDFN10 4x4, 0.8P  
CASE 511DU  
ISSUE 0

DATE 28 FEB 2017



LAND PATTERN RECOMMENDATION

NOTES:

- A. THIS PACKAGE DOES NOT FULLY CONFORM TO JEDEC MO-229, VARIATION VGGB
- B. ALL DIMENSIONS ARE IN MILLIMETERS
- C. LAND PATTERN IS FSC DESIGN WITH NOMINAL DIMENSIONS

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NEW STANDARD:		
DESCRIPTION:	WDFN10 4x4, 0.8P	PAGE 1 OF 2

